IPC ASSOCIATION ELECTRONICS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights r international and Pan-American copyright conventions.			ler both	This document is a declaration of the substances within the manufacturer listed level parts, the declaration encompasses all lower level materials for which the					rer listed in which the m	em. Note anufactur	: if the item is an as rer has engineering	sembly with lower responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information					
Supplier	• Information														
Company name*			Company unique ID			ı	Unique ID Authority					Response Date*			
nsemi											2024-05-19				
Contact Na	ame		Title - Contact]	Phone - Contact*				Email - Contact*				
Product-E	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized	d Representative*		Title - Representative]	Phone - Representative*				Email - Representative*				
Product-E	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Iter		n Number Mfr Item Name				Effective Date Version Manufacturing Si		Manufacturing Site	,	Weight*	UOM	Unit Type		
	NSVJ5908DSG5T1G NCH+NCH J-F		NCH+NCH J-FET			2024-05-19			CNG		7.9	mg	Each		
	cturing Proccess Inform						<u> </u>				,				
				Germinal Base Alloy J-STD-020 MS		L Rating				ature Max Time at Peak Temp			nber of Reflow Cyc	eles	
	contains Bi		CU Alloy	1			260		C	30	secon	ds 3			
Comments															
	aximum time at peak tempera														
or more i	information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale a											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.14	mg	Supplier	Silicon (Si)	7440-21-3		0.14	mg
Lead Frame	3.22	mg	Supplier	Silver (Ag)	7440-22-4		0.1027	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0061	mg
			В	Nickel (Ni)	7440-02-0		0.0174	mg
			Supplier	Iron (Fe)	7439-89-6		0.0805	mg
			Supplier	Copper (Cu)	7440-50-8		3.0088	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0045	mg
Mold Compound-Black	4.4	mg		Epoxy Phenol Resin	proprietary data		0.0352	mg
			Supplier	Carbon Black (C)	1333-86-4		0.044	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.52	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.528	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.0088	mg
Plating	0.08	mg	В	Bismuth (Bi)	7440-69-9		0.0005	mg
			Supplier	Tin (Sn)	7440-31-5		0.0795	mg
Wire Bond - Au	0.06	mg	Supplier	Gold (Au)	7440-57-5		0.06	mg